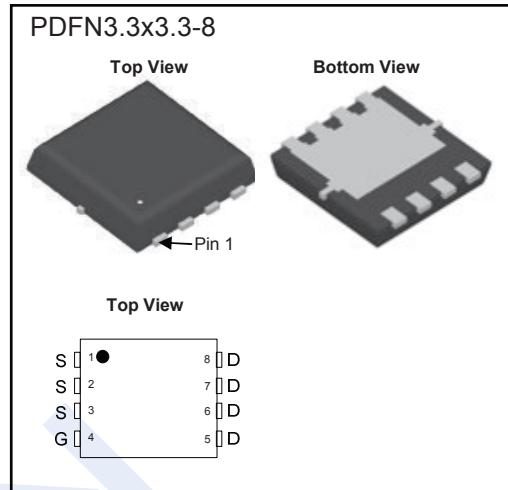
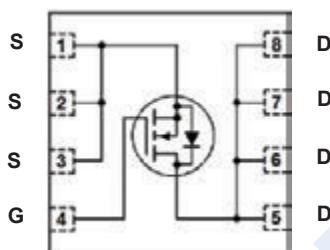


N-Channel MOSFET**2KK5082DFN****■ Features**

- V_{DS} (V) = 40 V
- I_D = 35 A (at V_{GS} = 10 V)
- $R_{DS(ON)}$ (at V_{GS} = 10 V) < 15 mΩ
- $R_{DS(ON)}$ (at V_{GS} = 4.5 V) < 19 mΩ

**■ Absolute Maximum Ratings ($TA = 25^\circ\text{C}$ unless otherwise noted)**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current (Note 1, 3)	I_D	35	A
		27	
Pulsed Drain Current (Note 2)	I_{DM}	70	W
Power Dissipation	P_D	25	
		9	
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{stg}	-55 to 150	

Notes:

1. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $TA=25^\circ\text{C}$. The value in any given application depends on the user's specific board design.
2. Repetitive rating, pulse width limited by junction temperature.
3. The current rating is based on the $t \leq 10\text{s}$ junction to ambient thermal resistance rating.

N-Channel MOSFET**2KK5082DFN****■ Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250 \mu\text{A}, V_{GS} = 0\text{V}$	40			V
Zero Gate Voltage Drain Current	$I_{DS(on)}$	$V_{DS} = 40\text{V}, V_{GS} = 0\text{V}$			1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			± 100	nA
Gate to Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0		2.2	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$		11	15	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 15\text{A}$		15	19	
Forward Transconductance	g_{FS}	$V_{DS} = 5\text{V}, I_D = 20\text{A}$	20			S
Dynamic Characteristics (Note 4)						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}, V_{DS} = 20\text{V}, f = 1\text{MHz}$		980	1200	pF
Output Capacitance	C_{oss}			130		
Reverse Transfer Capacitance	C_{rss}			80		
Total Gate Charge	Q_g	$V_{GS} = 10\text{V}, V_{DS} = 20\text{V}, I_D = 20\text{A}$		17		nC
Gate Source Charge	Q_{gs}			2.5		
Gate Drain Charge	Q_{gd}			4.5		
Switching Characteristics (Note 4)						
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 20\text{V}, R_L = 1\Omega, R_{GEN} = 3\Omega$		6		ns
Turn-On Rise Time	t_r			12		
Turn-Off Delay Time	$t_{d(off)}$			26		
Turn-Off Fall Time	t_f			7		
Drain-Source Diode Characteristics (Note 2,3)						
Maximum Body-Diode Continuous Current	I_S				35	A
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 1\text{A}$		0.75	1.2	V

Notes:

1. Repetitive rating, pulse width limited by junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10\text{ sec}$.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

■ Marking

Marking	K5082 KC***
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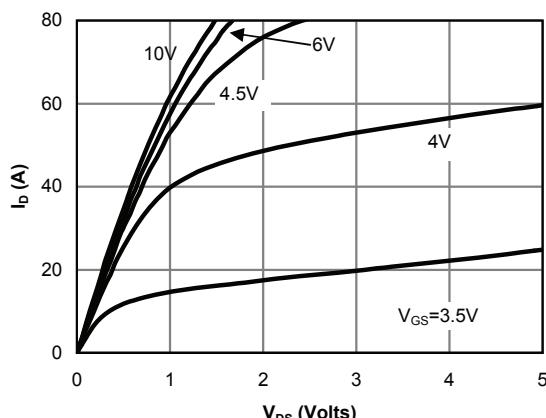
N-Channel MOSFET**2KK5082DFN****■ Typical Electrical And Thermal Characteristics**

Fig 1: On-Region Characteristics

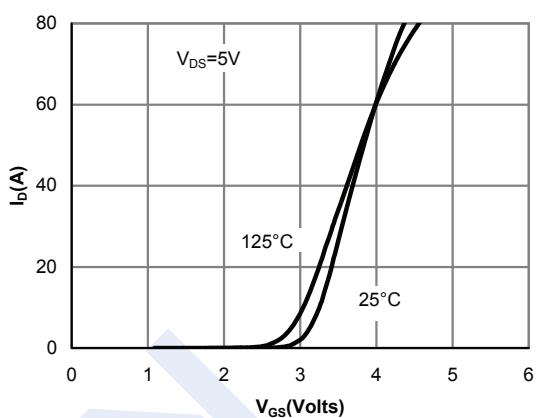


Figure 2: Transfer Characteristics

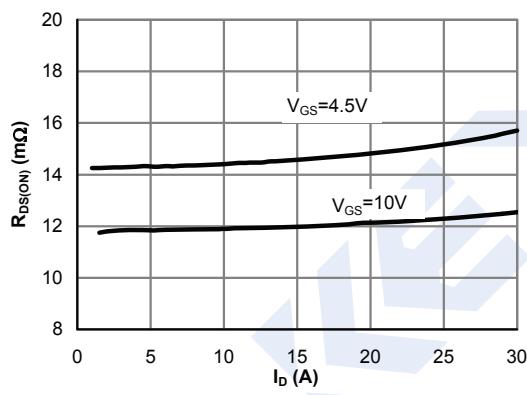


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

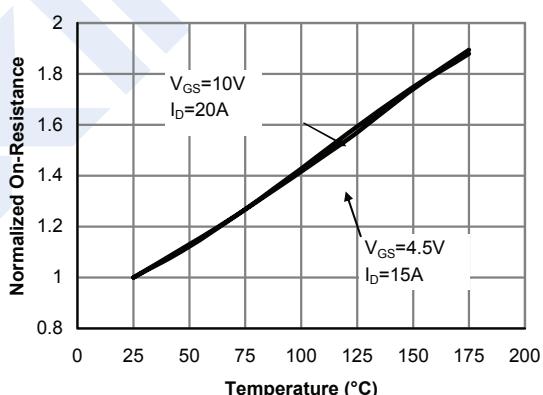


Figure 4: On-Resistance vs. Junction Temperature

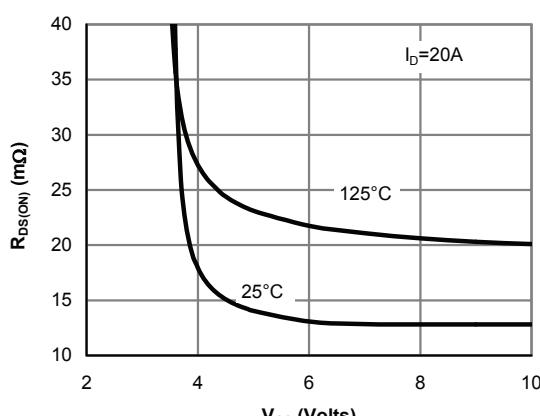


Figure 5: On-Resistance vs. Gate-Source Voltage

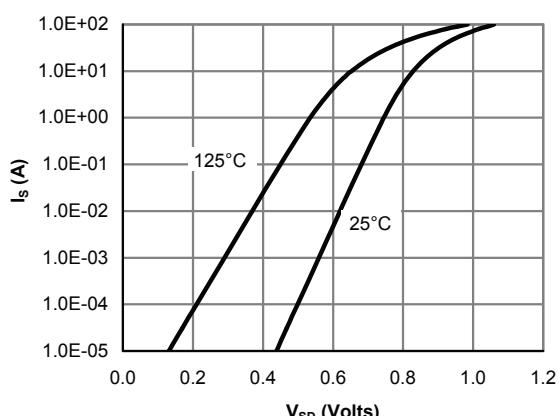


Figure 6: Body-Diode Characteristics

N-Channel MOSFET

2KK5082DFN

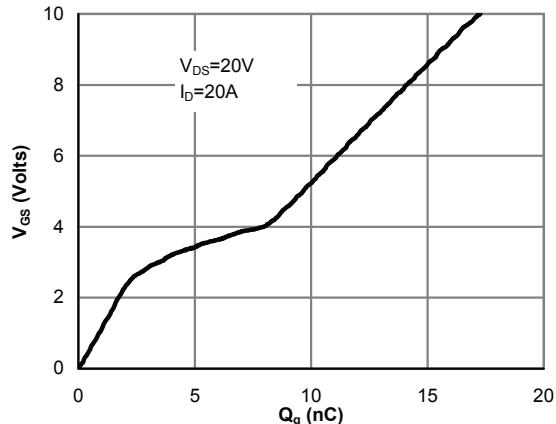


Figure 7: Gate-Charge Characteristics

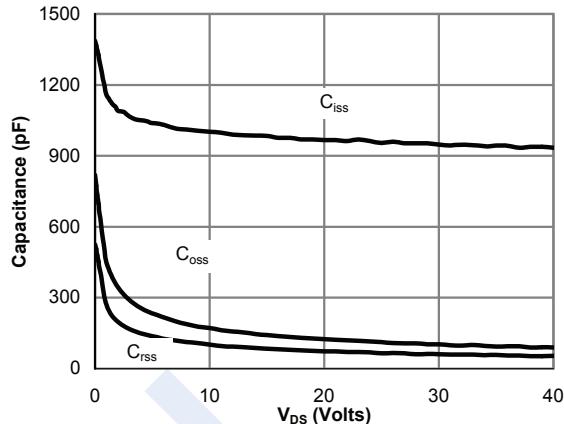


Figure 8: Capacitance Characteristics

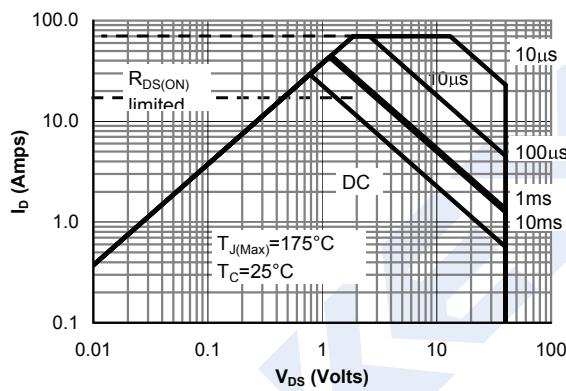


Figure 9: Maximum Forward Biased Safe Operating Area

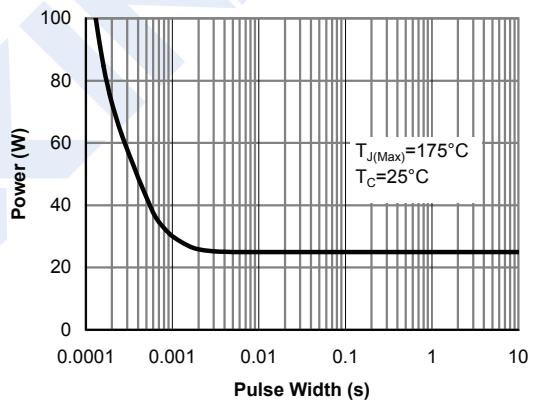


Figure 10: Single Pulse Power Rating Junction-to-Case

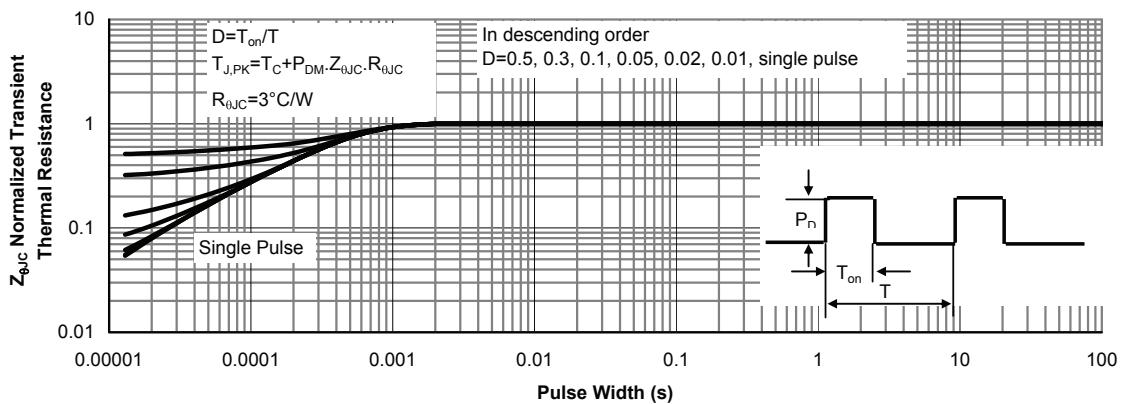
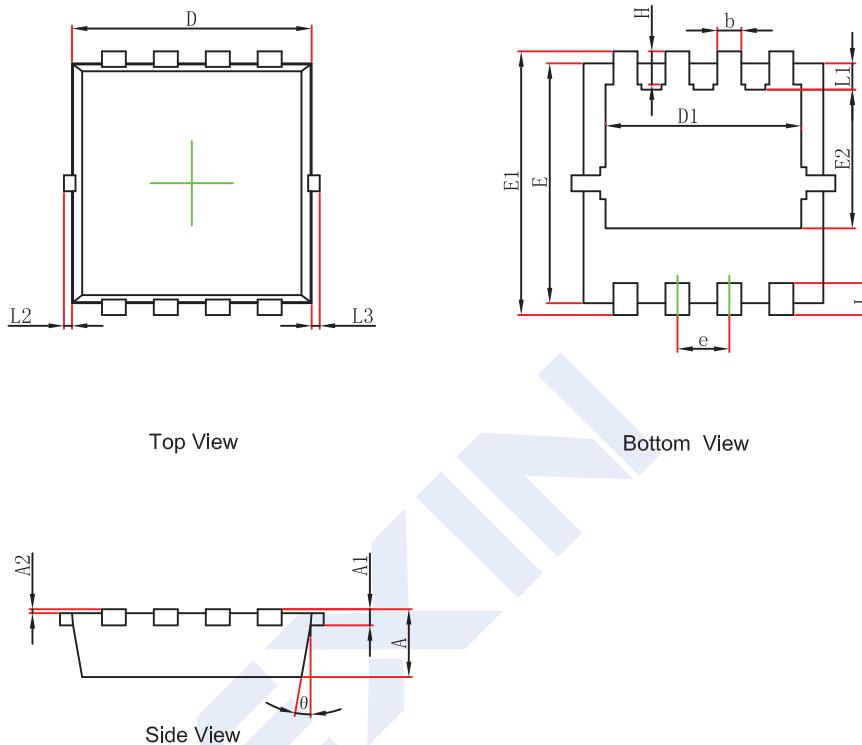


Figure 11: Normalized Maximum Transient Thermal Impedance

N-Channel MOSFET**2KK5082DFN****■ PDFN3.3x3.3-8 Package Outline Dimensions**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	3.050	3.250	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°